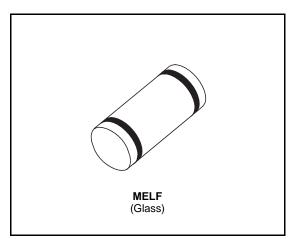


# **TMBYV 10-40**

# SMALL SIGNAL SCHOTTKY DIODES



## DESCRIPTION

Metal to silicon rectifier diodes in glass case featuring very low forward voltage drop and fast recovery time, intended for low voltage switching mode power supply, polarity protection and high frequency circuits.

Symbol	Parameter	Value	Unit	
V <sub>RRM</sub>	Repetitive Peak Reverse Voltage	40	V	
I <sub>F (AV)</sub>	Average Forward Current	T <sub>i</sub> = 60 °C	1	А
I <sub>FSM</sub>	Surge non Repetitive Forward Current	itive Forward Current $T_i = 25 \ ^{\circ}C \\ t_p = 10ms$		А
		T <sub>i</sub> = 25 °C t <sub>p</sub> = 300µs	50 Rectangular Pulse	
T <sub>stg</sub> T <sub>j</sub>	Storage and Junction Temperature Range	- 65 to 150 - 65 to 125	°C ℃	
ΤL	Maximum Lead Temperature for Solderin	260	°C	

# ABSOLUTE MAXIMUM RATINGS (limiting values)

# THERMAL RESISTANCE

Symbo	Parameter	Value	Unit			
R <sub>th (j -</sub>	Junction-leads	110	°C/W			
* Dulas tost: $t < 200 \text{us} = 5 < 20/$						

\* Pulse test:  $t_p \le 300 \mu s \ \delta < 2\%$ .

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#### ELECTRICAL CHARACTERISTICS STATIC CHARACTERISTICS

Synbol	Test Conditions			Тур.	Max.	Unit
I <sub>R</sub> *	T <sub>j</sub> = 25°C	V <sub>R</sub> = V <sub>RRM</sub>			0.5	mA
	T <sub>j</sub> = 100°C				10	ША
V <sub>F</sub> *	I <sub>F</sub> = 1A	T <sub>j</sub> = 25°C			0.55	V
	I <sub>F</sub> = 3A				0.85	

\* \* Pulse test:  $t_p \le 300 \mu s \ \delta < 2\%$ .

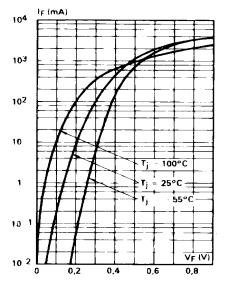
#### DYNAMIC CHARACTERISTICS

Symbol		Test Conditions	Min.	Тур.	Max.	Unit
С	$T_j = 25^{\circ}C$	V <sub>R</sub> = 0		220		pF

Forward current flow in a Schottky rectifier is due to majority carrier conduction. So reverse recovery is not affected by storage charge as in conventional PN junction diodes.

Nevertheless, when the device switches from forward biased condition to reverse blocking state, current is required to charge the depletion capacitance of the diode.

**Fig. 1 :** Forward current versus forward voltage at low level (typical values).



allel with a variable capacitance equal to the junction capacitance (see fig. 5 page 4/4).

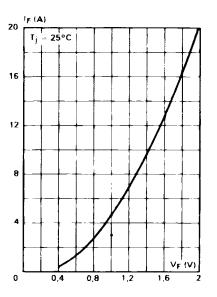
This current depends only of diode capacitance and

external circuit impedance. Satisfactory circuit be-

haviour analysis may be performed assuming that

Schottky rectifier consists of an ideal diode in par-

**Fig. 2**: Forward current versus forward voltage at high level (typical values).



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Fig. 3 : Reverse current versus junction temperature.

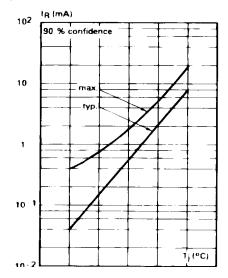


Fig. 5 : Capacitance C versus reverse applied voltage  $V_{\mathsf{R}}$  (typical values)

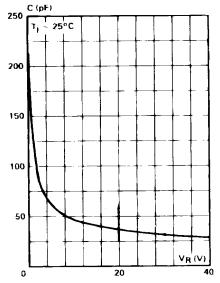
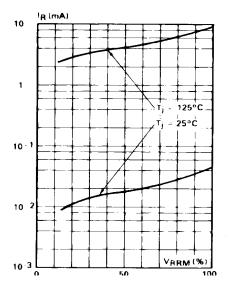
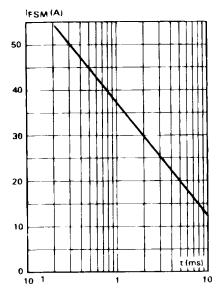


Fig. 4 : Reverse current versus VRRM in per cent.



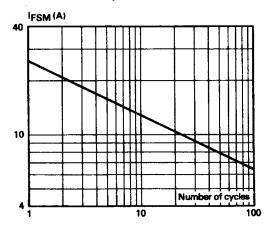
**Fig. 6 :** Surge non repetitive forward current for a rectangular pulse with t â 10 ms.

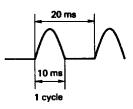


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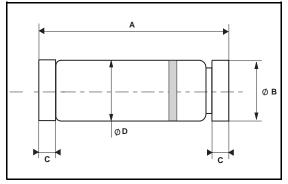
## **TMBYV10-40**

Fig. 7 : Surge non repetitive forward current versus number of cycles.

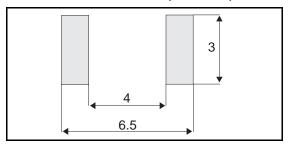




#### PACKAGE MECHANICAL DATA MELF Glass



### FOOT PRINT DIMENSIONS (Millimeter)



REF.	DIMENSIONS					
	Millimeters				Inches	
	Min.	Тур.	Max.	Min.	Тур.	Max.
А	4.80		5.20	0.189		0.205
ØB	2.50		2.65	0.098		0.104
С	0.45		0.60	0.018		0.024
ØD		2.50			0.098	

Cooling method: by convection and conduction Marking: ring at cathode end. Weight: 0.139g

**ORDERING CODE : TMBYV10-40 FILM** 

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